

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

July 19, 2006

In re the application of:

Seungbae Park et al.

Docket No. EN999048D

Filed: 03/27/2003

Art Unit: 1742

Serial No.: 10/038,264

Examiner: Ernesto Garcia

For: Solder interconnect techniques

Confirmation No. 8328

**REPLY TO NOTICE OF NON-RESPONSIVE AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated June 16, 2006, please consider the following:

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.